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Reduction of Potential-Induced-Degradation of p-Type PERC Solar Cell Modules by an Ion-Diffusion Barrier Layer Underneath the Front Glass

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Abstract: With the maturation of silicon-based technologies, silicon solar cells have achieved a high conversion efficiency that approaches the theoretical limit. Currently, great efforts are being made to enhance the reliability of silicon solar cells. When the silicon solar cells are made into modules, potential-induced-degradation (PID) occurs during operation because of the high voltage applied between the frame and the cells, which reduces the efficiency and output power. The diffusion of Na⁺ ions from the front glass and the increased leakage current along the migration path are the major causes of PID. In this work, atomic layer deposition (ALD)-grown amorphous thin Al₂O₃ layers are introduced underneath the front glass to prevent the diffusion of Na⁺ ions and the resulting PID. Accelerated PID tests showed that an ALD-grown Al₂O₃ layer of 30 nm could effectively suppress PID seriously affecting the conversion efficiency or light transmittance. The introduction of an ion-diffusion barrier underneath the front glass is expected to contribute to securing the long-term reliability of silicon-based electricity generation, together with the introduction of barrier layers inside the solar cells.

Keywords: potential-induced degradation; PERC solar cell module; ion-diffusion barrier; Al₂O₃

1. Introduction

As the demand for energy continues to increase worldwide, interest in eco-friendly renewable energy has accelerated because of the increasingly serious environmental pollution and global warming, which is recognized as the main culprit of climate change. Solar energy conversion devices, especially photovoltaic cells, have been regarded as most promising among the various types of renewable energy because of their unlimited reserves and high energy conversion efficiency [1,2]. Among the photovoltaic devices, crystalline silicon solar cells have developed most rapidly, because of their high conversion efficiency and a mature silicon-based industry; as a result, they account for more than 80% of the global solar cell market [3–6]. According to the Best Research-Cell Efficiency chart reported by the National Renewable Energy Laboratory, the highest cell efficiency for a single-crystalline silicon solar cell is 26.1%, achieved by the Institute for Solar Energy Research, Germany [7].

Most solar cell modules provided in the market guarantee operation for longer than 25 years. As the conversion efficiency approaches the theoretical limit of 29%, the interest is shifting from efficiency to long-term stability.

When silicon solar cell modules are connected in series to produce a high voltage of 600–1000 V, the same high voltage is applied between the grounded module frame and the solar cell, which causes a large leakage current and loss of power output during the production of electricity. This is referred to as potential-induced-degradation (PID), which



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Copyright: © 2022 by the authors. Licensee MDPI, Basel, Switzerland. This article is an open access article distributed under the terms and conditions of the Creative Commons Attribution (CC BY) license (https:// creativecommons.org/licenses/by/ 4.0/). deteriorates the photovoltaic performance of crystalline silicon solar cell modules over a long period of time [8–12].

PID is known to occur as a result of the diffusion of Na^+ ions present in the soda-lime front glass that is generally used for silicon solar cell modules and contains 12% Na_2O . When a high voltage is applied, Na^+ ions inside the front glass diffuse into the cells across the encapsulant and anti-reflection coatings. The diffused Na^+ ions accumulate at the interface between the anti-reflection coatings and the cells or at the stacking faults inside the silicon, which forms a conduction path, leading to a large leakage current [13–17], which gradually degrades the conversion efficiency and maximum power output of the modules.

The PID can be reduced by adjusting the refractive index of the anti-reflection coatings formed on top of the cells. As the refractive index of silicon nitride (SiN_x) , which is typically used for the anti-reflection coating of silicon solar cells, increases, the conductivity also increases, resulting in a reduction in the migration of positively charged ions to SiN_x . This effectively enhances the resistance to PID. However, if the refractive index becomes higher than 2.14, light with a short wavelength cannot be absorbed by silicon, causing a decrease in the cell efficiency as a result of the reduction in the photocurrent [16–18].

An alternative way to prevent PID is to insert a layer that can block the penetration of ions from the glass [19,20]. This layer can be located between the front glass and the front encapsulant or between the anti-reflection coating and the cell. These blocking layers are known to effectively suppress the diffusion of Na⁺ ions inside the glass and the shunting path and consequently reduce PID. Possible candidates for this blocking layer include Al_2O_3 , TiO₂, and SiO₂ [21–23]. Previous work done by Jung et al. shows that an ultrathin layer of SiO_x formed between the cell and the anti-reflection coating effectively reduces PID [24].

Herein, we explored the effect of Al_2O_3 thin layers, which are known to have high light transmittance with outstanding barrier performance against ion diffusion, on the reduction of PID in silicon solar cell modules. As the thickness of Al_2O_3 increased, the PID was remarkably reduced, and a 30 nm layer of Al_2O_3 could suppress PID effectively.

2. Materials and Methods

Ions can diffuse through the grain boundaries in crystalline Al_2O_3 layers, and an amorphous phase of Al_2O_3 is required for suitable performance as a diffusion barrier. For this purpose, thermal atomic layer deposition (ALD) was utilized for the growth of the Al_2O_3 ion diffusion barrier layers. Soda-lime glass and quartz were cut to a size of 5 cm \times 5 cm. These substrates were first ultrasonically cleaned with acetone, methanol, and isopropyl alcohol sequentially for 15 min each and finally rinsed with deionized water. The cleaned glass substrates were then dried in a thermal ALD chamber at 150 °C for 30 min. Thermal ALD of Al_2O_3 was performed at the same temperature with trimethylaluminum (TMA, $Al(CH_3)_3$) and H_2O as the precursor and reactant, respectively. During each cycle, the substrate was exposed to the precursor for 0.2 s, followed by purging with 80 sccm of Ar for 20 s.

Structural characterization was performed using X-ray diffraction (Empyrean, Malvern Panalytical, Malvern, UK) and scanning electron microscopy (JSM-7610F Plus, Jeol, Tokyo, Japan). The light transmittance was measured using UV-vis spectroscopy (Optizen POP, K LAB, Daejeon, Korea) for 10 to 30 nm Al_2O_3 films deposited on quartz substrates.

To characterize the PID, an acceleration test was performed using IEC62804-1, an internationally recognized standard-based solar cell test device [25]. For silicon solar cells, passivated emitter and rear contact (PERC) cells, which represent the largest portion of the market, were used. As shown in Figure 1, p-type PERC solar cells, encapsulants, and Al_2O_3 -grown sola-lime glass were placed on an aluminum chuck heated to 60 °C on a hot plate [26]. Then, a 2-kg weight was loaded on top of the glass and +1000 V was applied to the bottom aluminum chuck for 96 h. Light I-V curves and electroluminescence (EL) images were obtained to evaluate the effect of the blocking layers on PID. To ensure testing uniformity, four module-like layer stacks underwent an accelerated test at the same time.

Note that PERC solar cells without oxidation layers inserted between the anti-reflection coating and the cell were examined because these oxidation layers inside the cells are known to prevent PID as well.



Figure 1. Schematic of the accelerated PID test. A 2 kg weight made of aluminum was used. Four module-like stack samples were tested at the same time. After 96 h, each stack was disassembled, and I-V measurements were performed.

3. Results and Discussion

3.1. Characterization of the ALD-Grown Al₂O₃ for Si-Solar Cell Usage

3.1.1. Uniform Growth of Al₂O₃ with Amorphous Structure

Figure 2 shows the SEM plan view and cross-section view images of the ALD-grown Al_2O_3 thin films on Si wafer (a) and glass (b), (c). For both Al_2O_3 films, the calibrated growth rate was 1.3 Å/cycle. SEM plan view images of the Al_2O_3 films, as shown in Figure 2a,b, allow reasonable doubt regarding the polycrystalline microstructure. However, all the ALD-grown Al_2O_3 thin films investigated in this work exhibited an amorphous structure, which is confirmed by the absence of a pronounced XRD peak (not shown), as is generally expected for films grown by ALD.



Figure 2. SEM plan view images of the ALD-grown Al₂O₃ thin films on (**a**) single crystalline Si wafer, (**b**) glass. (**c**) SEM cross-section view image of the ALD-grown Al₂O₃ thin films on a glass.

3.1.2. Optical Transmittance and Passivation Properties of Al₂O₃ Thin Films

Prior to the accelerated PID test, the light transmittance of Al_2O_3 -coated quartz substrates with various Al_2O_3 thicknesses was characterized, as shown in Figure 3a,b. Note that light transmittance through the glass and light absorption by silicon decreased with a thick Al_2O_3 layer. As presented in Figure 3a, the light transmittance in the wavelength range of 200–300 nm was slightly reduced with increasing thickness of Al_2O_3 . However, the average transmittance for the 200–1000 nm range was greater than 94% and independent



of the Al₂O₃ thickness, although the transmittance for 30 nm was slightly smaller than the others.

Figure 3. (a) Light transmittance for 200 to 1000 nm range of ALD-grown Al_2O_3 thin films with various thicknesses. (b) Average light transmittance with respect to the thickness of the Al_2O_3 layer. (c) Capacitance-voltage profile of a p-type single-crystalline silicon wafer passivated by the ALD-grown 10 nm Al_2O_3 thin layers.

To further confirm the validity of the ALD process used in this work for Al_2O_3 thin film growth, we examined the surface passivation properties using capacitance-voltage measurements. For 10 nm-thick Al_2O_3 films grown on p-type single-crystalline Si wafers, the capacitance-voltage profile shifted to a positive bias after annealing, as shown in Figure 3I, which is indicative of negatively charged Al_2O_3 thin films with the appropriate passivation properties of well-grown Al_2O_3 thin films.

3.2. Accelerated PID Test with Light I-V and Electroluminescent Measurement

The results of the accelerated PID tests are shown in Figure 4. As mentioned in the Materials and Methods section, the current and voltage with and without light were measured before and after loading a 2 kg weight for 96 h. Note that the reference sample is the initial module before the accelerated PID test. The rest of the samples correspond to the measurement results after the accelerated PID test with respect to the designated Al₂O₃ layer thickness. Before the PID test, all the modules showed similar I-V characteristics; therefore, only the module without the Al₂O₃ layer was used as the reference.

As shown in Figure 4a, the Al_2O_3 layer deposited underneath the front glass can effectively prevent PID. Without the Al_2O_3 diffusion barrier, V_{oc} was remarkably reduced, from 0.658 V to 0.572 V. However, a 10 nm-thick layer of Al_2O_3 recovers V_{oc} to that of the reference module. J_{sc} does not change significantly, which can be inferred from the similar light absorption properties presented in Figure 3. All the modules exhibited similar series resistance, which can be obtained from the slope that crosses the voltage axis, regardless of the presence of the Al_2O_3 diffusion barrier layer. However, slopes that cross the current axis showed different behavior; the module without the Al_2O_3 layer showed a quite stiff slope, whereas the slopes of the modules with the Al_2O_3 layer recovered close to that of the reference. This is predictable because the leakage current that causes PID is related to the shunt resistance and not to the series resistance.

Although the V_{oc} and J_{sc} of the cells with Al₂O₃ layers were almost the same, regardless of the thickness of Al₂O₃, the change in the fill factor and the solar conversion efficiency of each module were remarkably reduced in cells with an Al₂O₃ layer, as shown in Figure 4b. The fill factor decreased from 75.3% to 72.4% without the Al₂O₃ layer, while it recovered to its initial value when employing an Al₂O₃ layer of only 10 nm. Without the Al₂O₃ layer, the conversion efficiency deteriorated significantly; it dropped by approximately 18.8% after the PID test. However, as the thickness of Al₂O₃ increased, the efficiency drop tended to decrease, even though there was some fluctuation. Even with only 10 nm of Al₂O₃, the efficiency after the PID test for 96 h was 19.92%, which indicates that the efficiency



decreased by approximately 2.54%. When the thickness of Al_2O_3 was 30 nm, the efficiency loss was only 0.98% after the PID test.

Figure 4. Characterization results of PERC cells after the accelerated PID test. (**a**) Light I–V, (**b**) efficiency changes, electroluminescent images obtained after the PID test; (**c**) ref—before the PID test, (**d**) without the Al₂O₃ layer, (**e**) 10 nm Al₂O₃, and (**f**) 30 nm Al₂O₃.

PID causes the formation of defects inside the cell, which can be analyzed by EL. As presented in Figure 4c–f, lots of defects were generated, possibly due to the diffusion of Na⁺ ions, after the PID test when no Al_2O_3 layer was inserted. Although 10 nm-thick Al_2O_3 demonstrated a quite reduced PID as shown in light I-V measurement results, EL images of 10 nm indicated that there were still non-negligible number of defects. It could be confirmed that the defects caused by the diffusion of Na⁺ ions disappeared only when the thickness was 30 nm.

From the light I-V measurement and EL results, it can be concluded that the optimum thickness of Al₂O₃, the diffusion barrier of Na⁺ ions from the front glass, is 30 nm. All the changes of the photovoltaic parameters with various Al₂O₃ thicknesses after the accelerated PID test were summarized in Table 1.

Table 1. Photovoltaic parameters with various Al_2O_3 thicknesses after the accelerated PID test. The changes with respect to the values of reference sample are shown together in the parentheses.

Sample	V _{OC} (V)	J _{SC} (mA/cm ²)	FF (%)	Efficiency (%)
Reference	0.658	41.24	75.3	20.44
0 nm Al_2O_3	0.572	40.08	72.4	16.6
	(-13.07%)	(-2.81%)	(-3.85%)	(-18.79%)
$10 \text{ nm Al}_2\text{O}_3$	0.658	40.32	75.1	19.92
	(0%)	(-2.23%)	(-0.27%)	(-2.54%)
$20 \text{ nm Al}_2\text{O}_3$	0.655	40.48	70.9	18.8
	(-0.46%)	(-1.84%)	(-5.84%)	(-8.02%)
30 nm Al ₂ O ₃	0.658	40.28	76.4	20.24
	(0%)	(-2.32%)	(1.46%)	(-0.98%)

According to V. Naumann et al., an accumulation of alkali metals should be found at the interface of the front side coatings of the solar cell, which can be demonstrated by lock-in thermography (LIT), and time-of-flight secondary ion mass spectroscopy (ToF-SIMS), when PID occurs [27]. Further investigation using these analysis techniques would manifest the correlation between the occurrence of PID and the diffusion of Na⁺ ions.

4. Conclusions

The improvement in solar cell efficiency has received much recent attention, and intensive research to achieve higher efficiency has been conducted. However, with the widespread use of solar cells, long-term reliability has become another important aspect. PID is regarded as a major source of deterioration that occurs during operation when silicon-based solar cells are made into modules. The diffusion of Na⁺ ions into the cells and the resulting increase in leakage current are one of the main causes of PID. When ALD-grown amorphous Al₂O₃ thin layers of 30 nm are introduced underneath the front glass of the module, PID is effectively prevented without a serious decrease in the V_{oc}, J_{sc}, or solar conversion efficiency. This method is expected to have a greater effect when this Na⁺ ion-diffusion barrier is combined with the insertion of another barrier layer between the anti-reflection coatings and solar cells.

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